

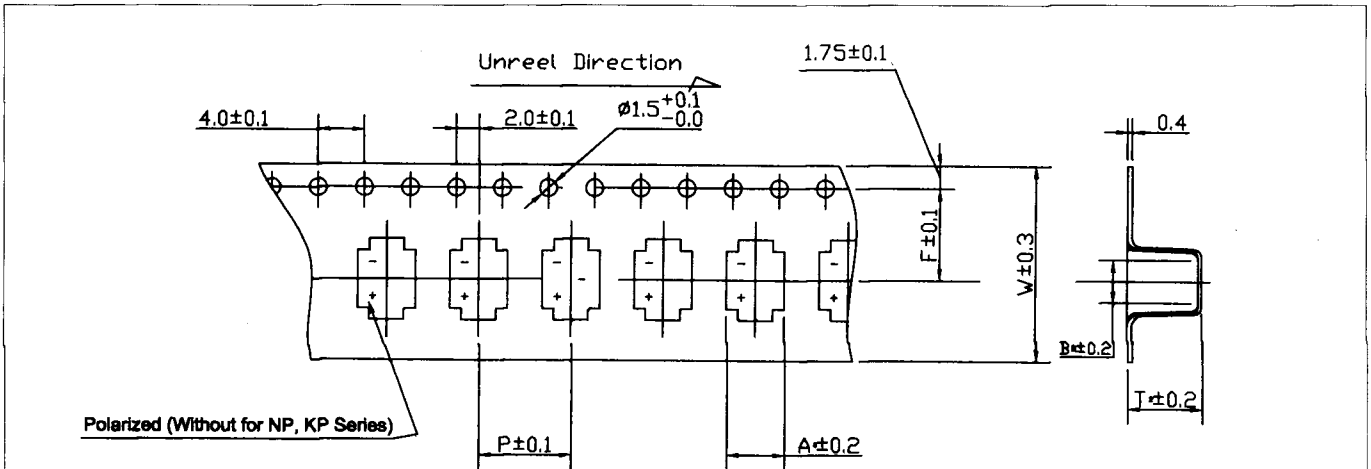
V-CHIP ALUMINUM ELECTROLYTIC CAPACITORS 片式铝电解电容器

• Taping Specification 编带标准

• Applicable standard JIS C0806

(SS, HT, NP, KP, LZ, KZ, EL, KL, KH series)

• Carrier Tape 袋带

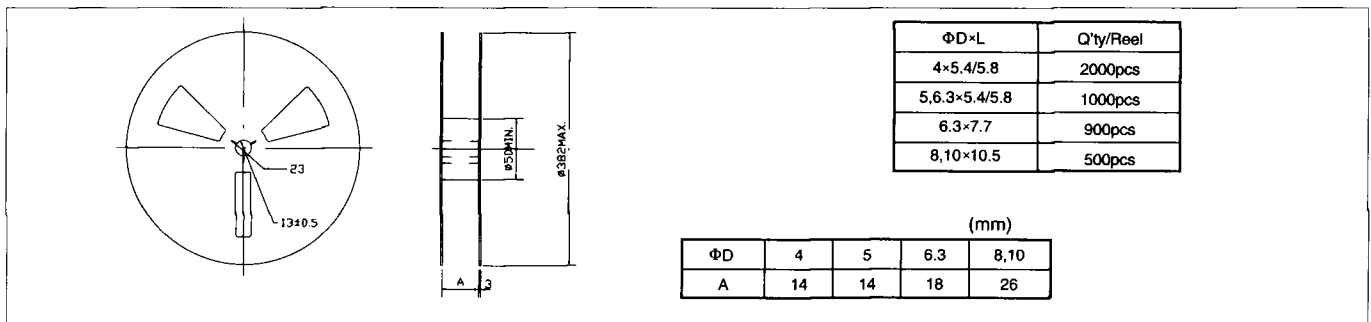


Dimension 尺寸

(mm)

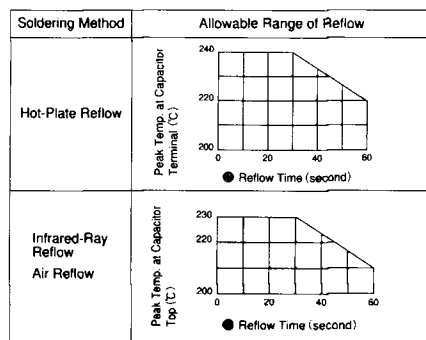
Series	SS	HT	NP	LZ	KP	EL	KZ	KL	SS	HT	NP	LZ	KZ	EL	KL	KH
ΦD×L	4×5.4	5×5.4	6.3×5.4	4×5.8	5×5.8	6.3×5.8	6.3×7.7	8×10.5	10×10.5							
W	12.0	12.0	16.0	12.0	12.0	16.0	16.0	24.0	24.0							
P	8.0	12.0	12.0	8.0	12.0	12.0	12.0	16.0	16.0							
F	5.5	5.5	7.5	5.5	5.5	7.5	7.5	11.5	11.5							
A ₀	5.0	6.0	7.0	5.0	6.0	7.0	7.0	8.7	10.7							
B ₀	5.0	6.0	7.0	5.0	6.0	7.0	7.0	8.7	10.7							
T ₁	5.8	5.8	5.8	6.3	6.3	6.3	8.4	11.0	11.0							

• Reel 卷盘

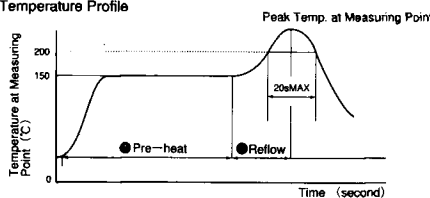


• Soldering Method and Allowable Range of Reflow

• Recommended Land Size



Temperature Profile



Size	(mm)		
	X	Y	a
Φ4	1.6	2.6	1.0
Φ5	1.6	3.0	1.4
Φ6.3	1.6	3.5	2.1
Φ8×10.5	2.5	3.5	3.0
Φ10×10.5	2.5	4.0	4.0

Pre-heating shall be done less than +150°C and 90 seconds, respectively.
 The temperature at capacitor top shall not exceed +230°C.
 The duration for over +200°C temperature at capacitor top shall not exceed 20 seconds.
 The standard temperature profile differs by every reflow method.
 If capacitors are subject to the conditions other than the allowable range of reflow, please contact us.